

Solution Processed OLEDs for Display and Lighting Applications

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Agenda

- DuPont materials and process for OLED Displays
- Introduction to OLED lighting work at DuPont

Future of OLED requires new manufacturing technology

Evaporation with fine metal masks has very high cost

- Material waste is very high
- Motherglass size is limited
- Evaporators are expensive
- Shadowmasks are costly and have to be cleaned, inspected and replaced

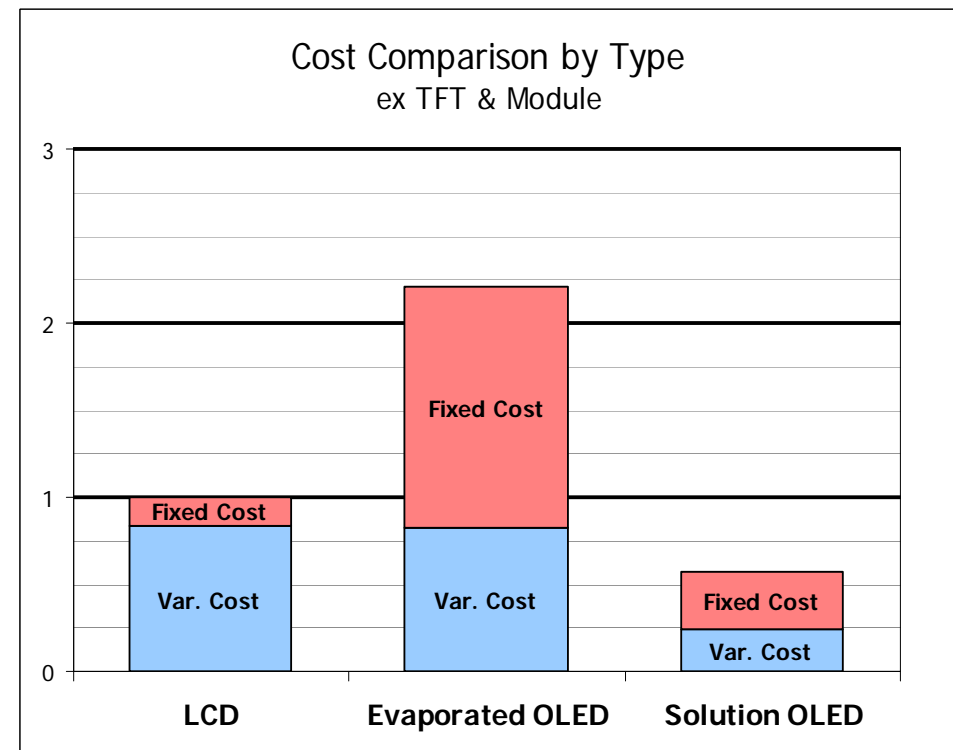
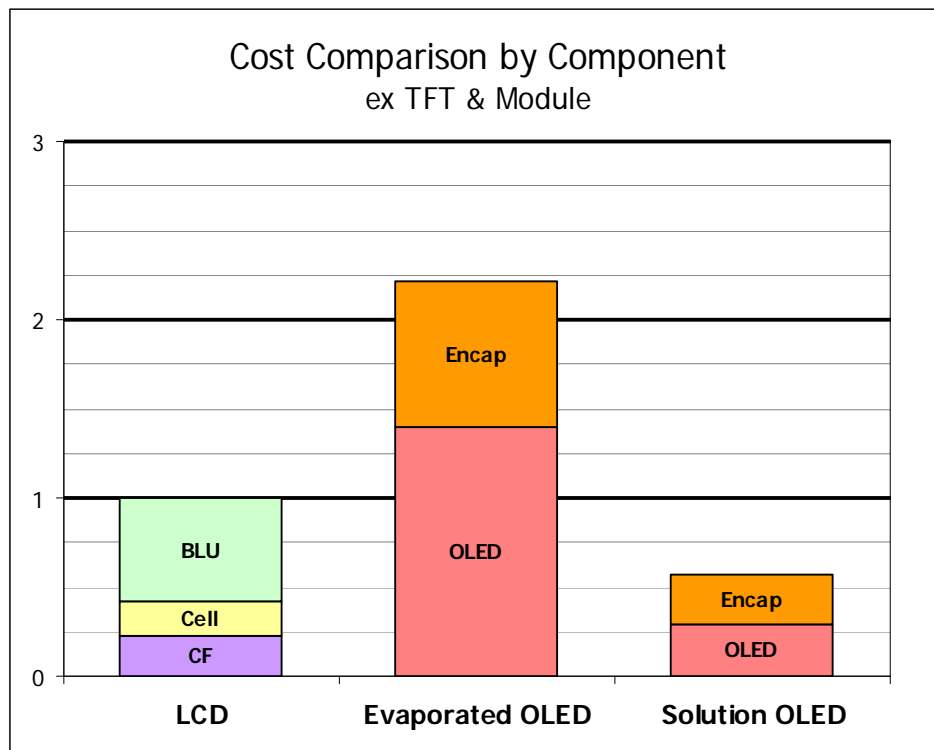
Solution printing a good answer

- High material utilization
- Printing can scale to any size motherglass
- Printers are much less expensive than evaporators
- No fine metal shadowmasks

Solution printing is the key to economical manufacturing at large motherglass size

Solution Processing Addresses Today's Cost Issues

- Efficient material use reduces variable cost and takes advantage of OLED's smaller bill of materials (BOM)
- Low TACT, scalable processes increase fixed cost productivity
- Scalable and more economical equipment increases capital productivity
- Integrated development of both materials and processes was necessary to meet OLED performance requirements and manufacturing cost goals

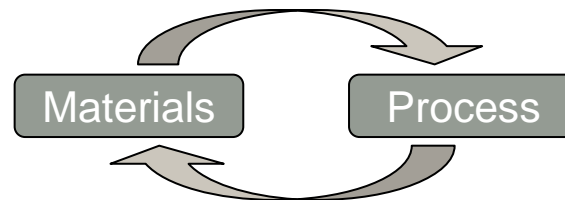


Why isn't everyone using solution OLED already?

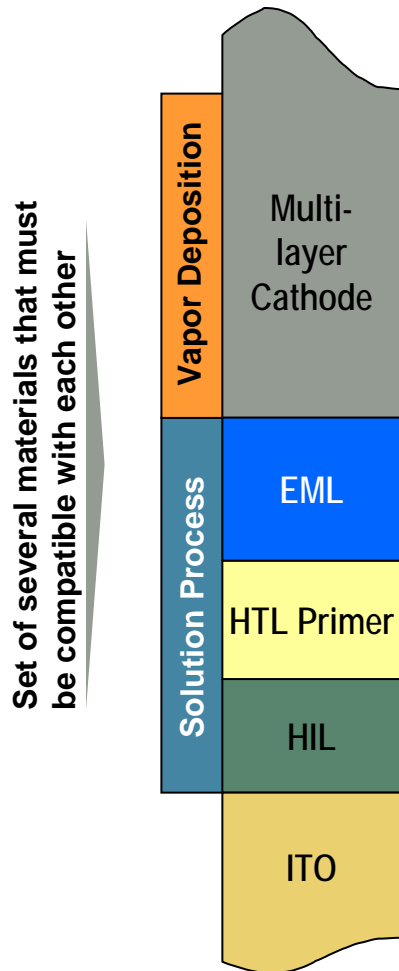
Greatest challenge is developing high-performance solution OLED materials

In addition to performance, materials development needs to help solve key process issues:

- How to coat the “blanket” layers?
- How to contain the printing inks in the active subpixel area?
- How to keep successive layers from mixing with each other?
- How to clean the coated materials before encapsulation/bonding?
- How to print at high speed without visual defects?
- How to keep atmospheric conditions during printing/coating from degrading the organic materials?



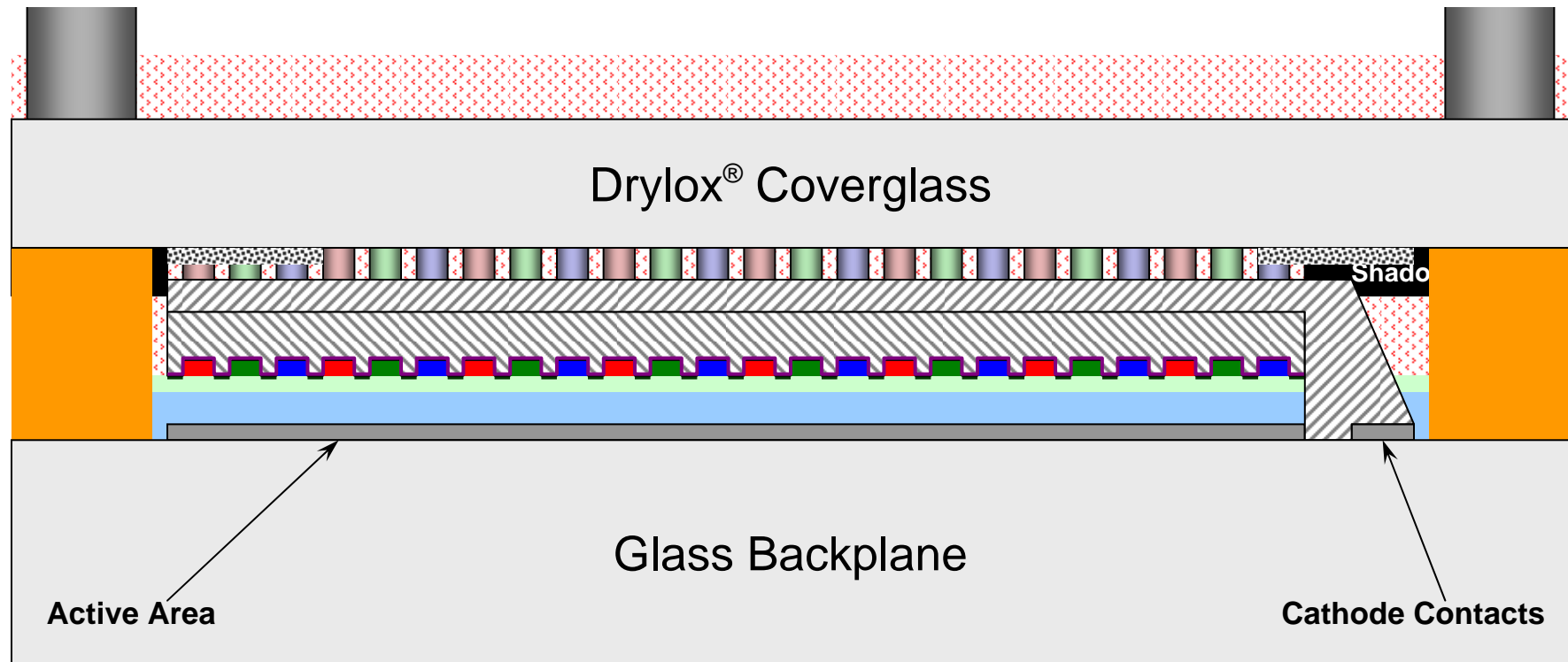
DDI Solution OLED Process – Fundamental Principles



Reduce the cost of manufacturing:

- **Solution process as many layers in the OLED stack as possible**
 - Eliminates capital intensive processing (e.g. thermal evaporation)
 - Provides for a more efficient use of materials
 - Requires close tailoring of materials and manufacturing process
- **Pattern minimum number of layers – use common layer architecture and manage performance tradeoff**
- **When patterning is required; employ a robust, reliable tool for the patterned layer – Nozzle Printer**
- **Employ standard FPD industry equipment, e.g. slot coating**
- **When specialized equipment is required, we partner with recognized FPD equipment maker (DNS for nozzle printer)**

DuPont Solution OLED Process Overview



Slot coat HIL and Primer Layers

Modify Primer Surface to Form Wetting & Non-Wetting Lanes

Multinozzle Print EML Layers

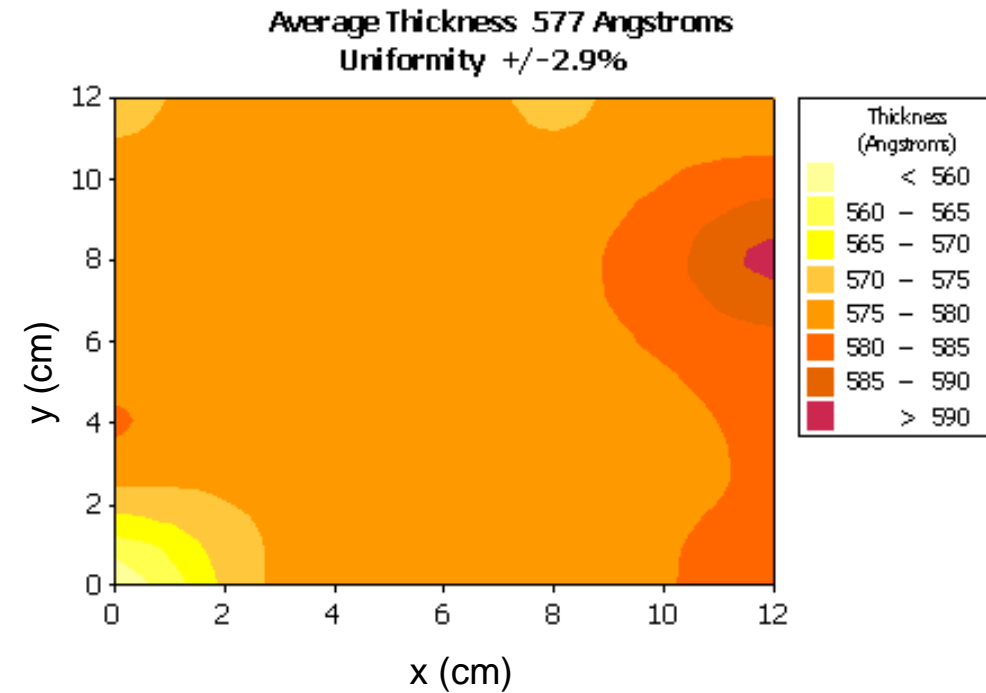
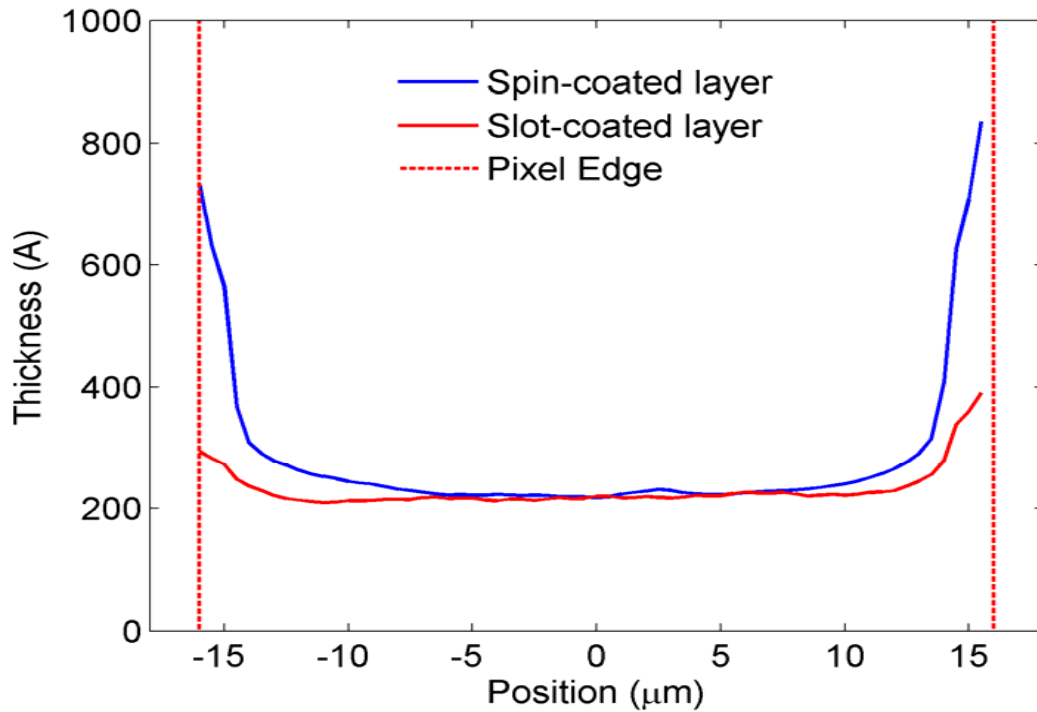
Evaporate ETL, EIL & Metal Cathode over Active Area

Plasma Etch Excess Organic Layers Using Cathode as Etch Mask

Evaporate Cathode Connection

Dispense Epoxy & Encapsulate

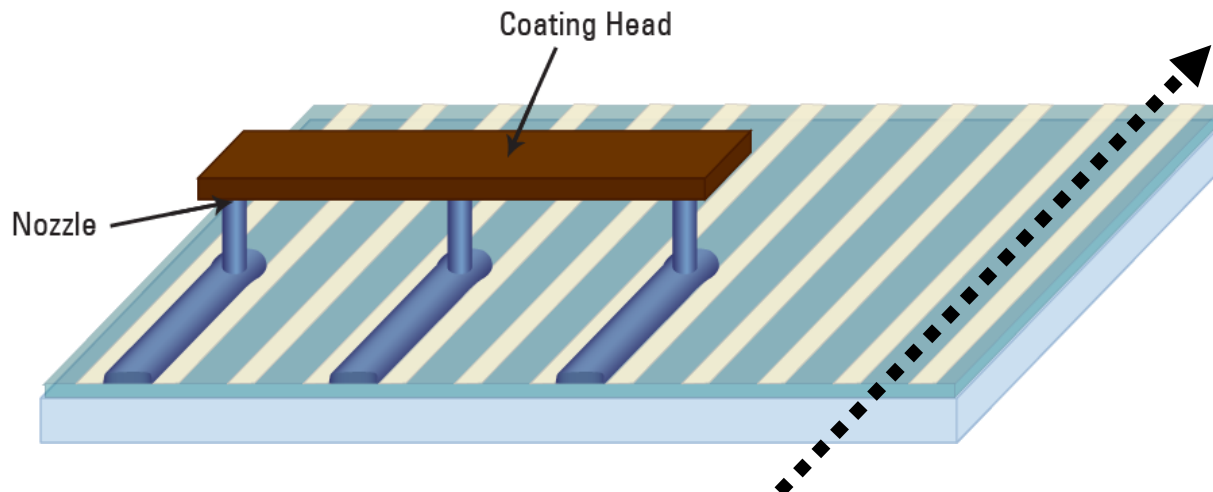
Slot-die Coated Common Layers



DuPont and Dainippon Screen (DNS): Nozzle Printing for Solution OLED Display Patterning

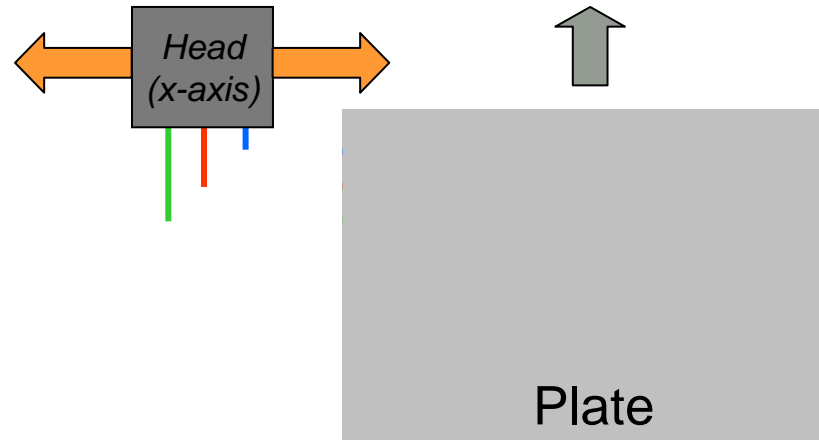
**1st Gen 4 production scale printer
installed in Santa Barbara in 4Q, 2008
(for 730mm x 920mm glass)**

- **High throughput – 15 nozzles**
- **TACT is <3 min per Gen 4 substrate**
- **Excellent printing uniformity**
- **High material utilization**

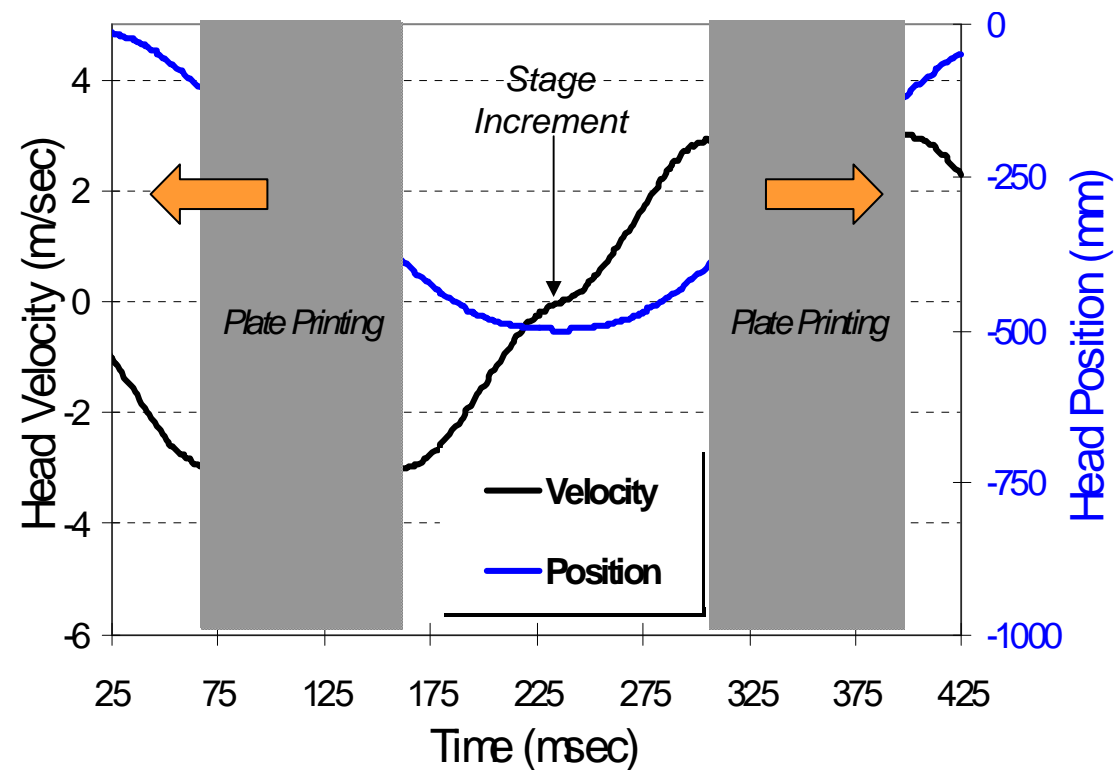


Nozzle Printer Patterning

Stage Increment (y-axis)

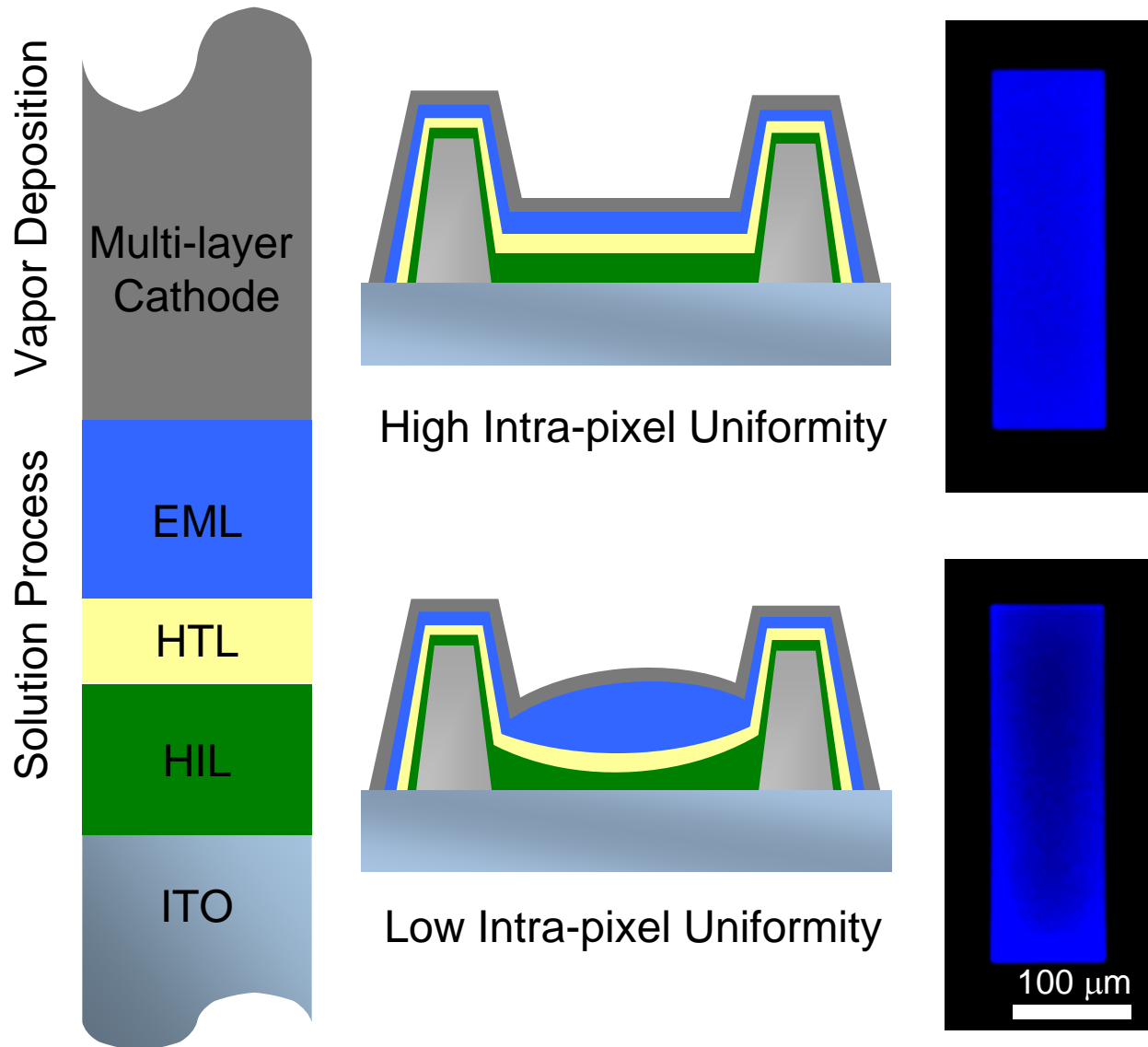


- Synchronized x- and y-axis movement
- Head velocity 2 - 5 m/s
- Acceleration up to 10G



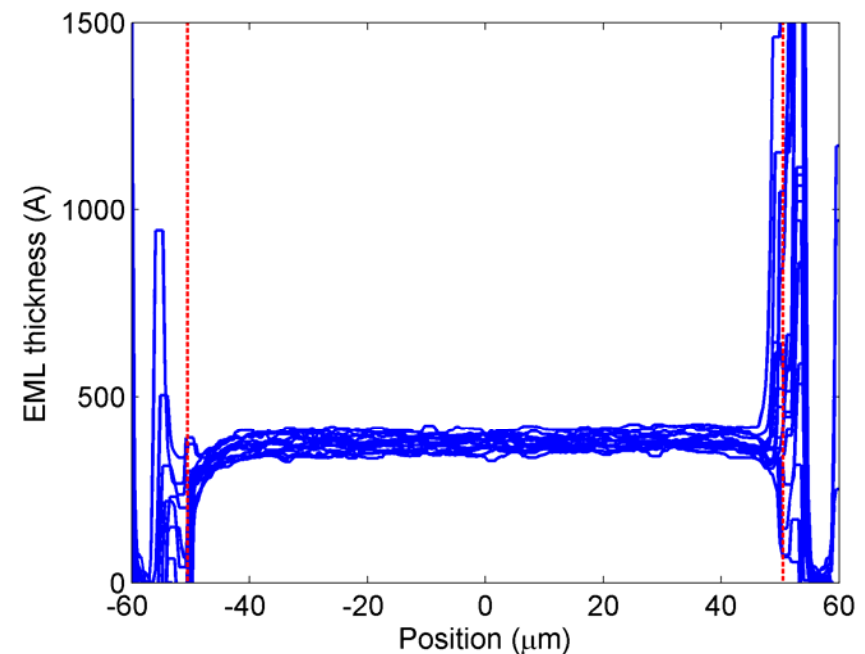
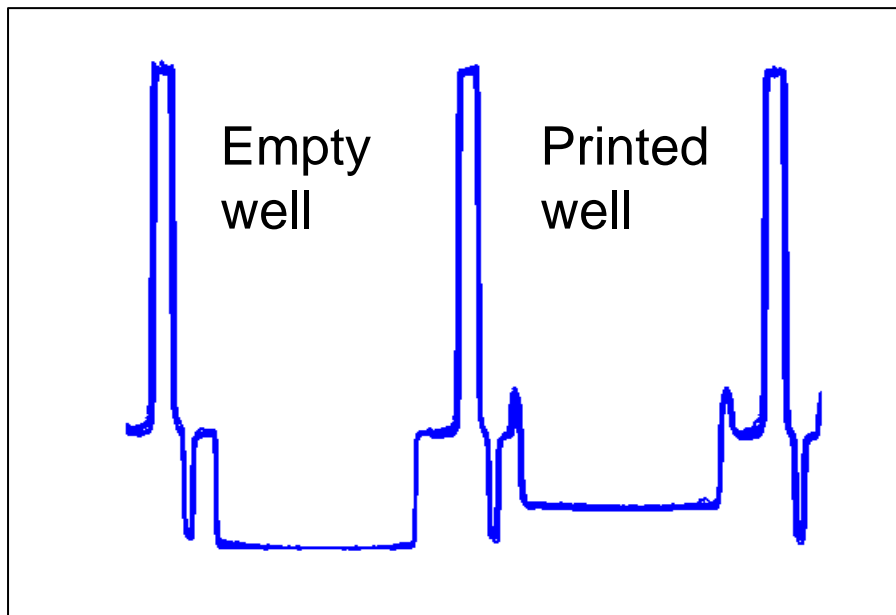
Intra-pixel uniformity

Low in-pixel uniformity lowers device performance, introduces mura

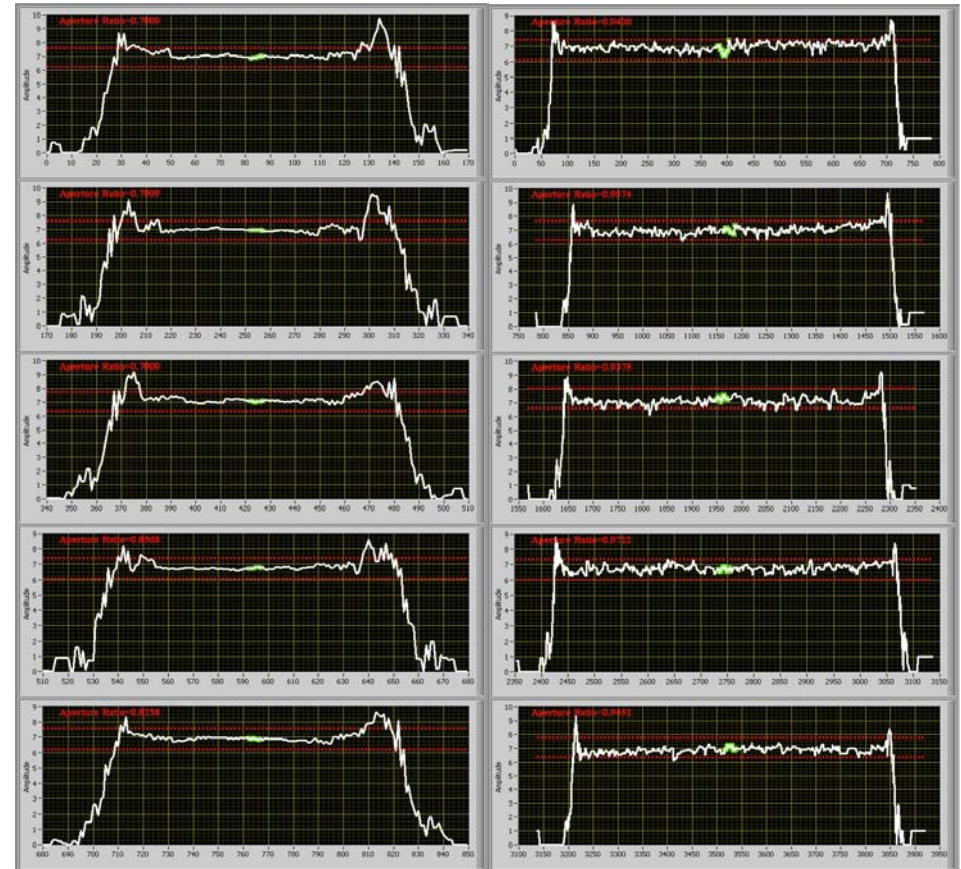
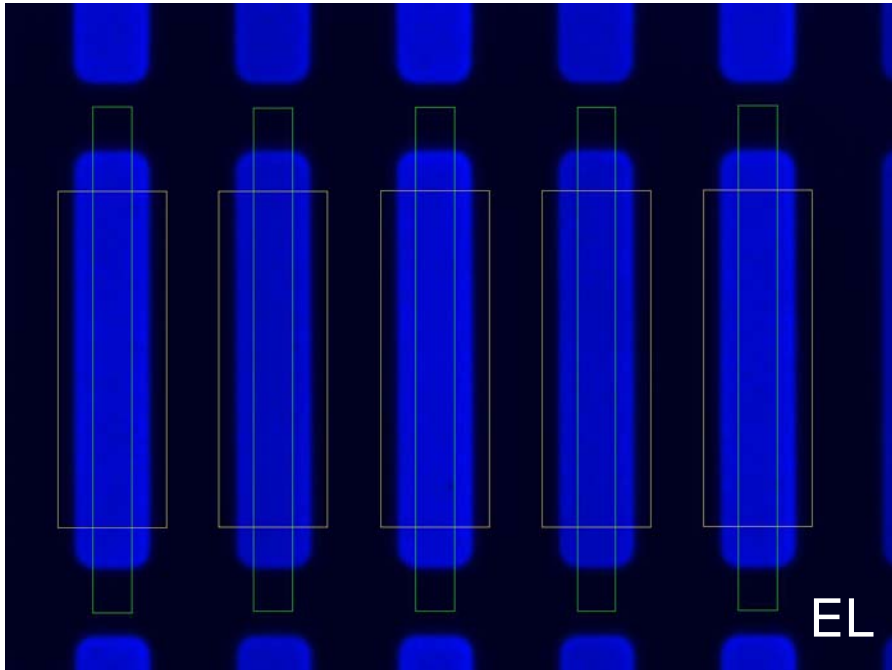


Intra-Pixel Thickness Uniformity Measurement

- Use stylus profilometer to scan 16 locations on a 150x150 mm printed substrate.
- Custom software analysis extracts printed layer thickness throughout the pixel.
- > 95% thickness aperture is achievable.
- ~ 2 nm thickness variation across the plate: Long range uniformity > 90%

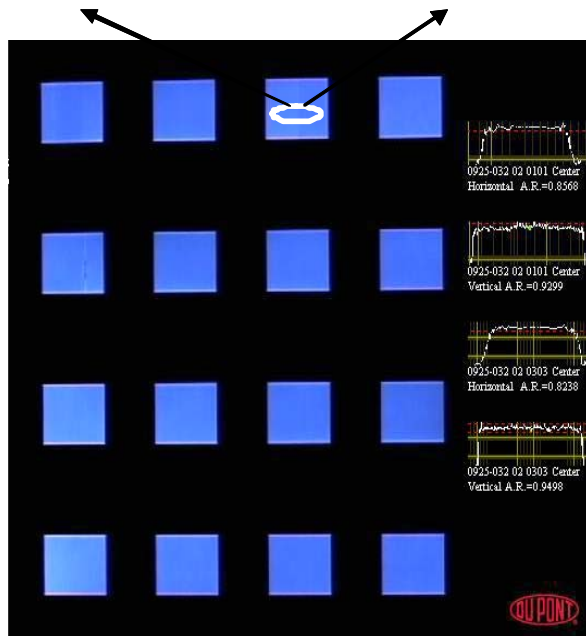


Intra-Pixel Luminance Uniformity – Standard Printed Parts



Horizontal Results

Vertical Results



Achieved by high intra-pixel layer uniformity for all solution coated layers

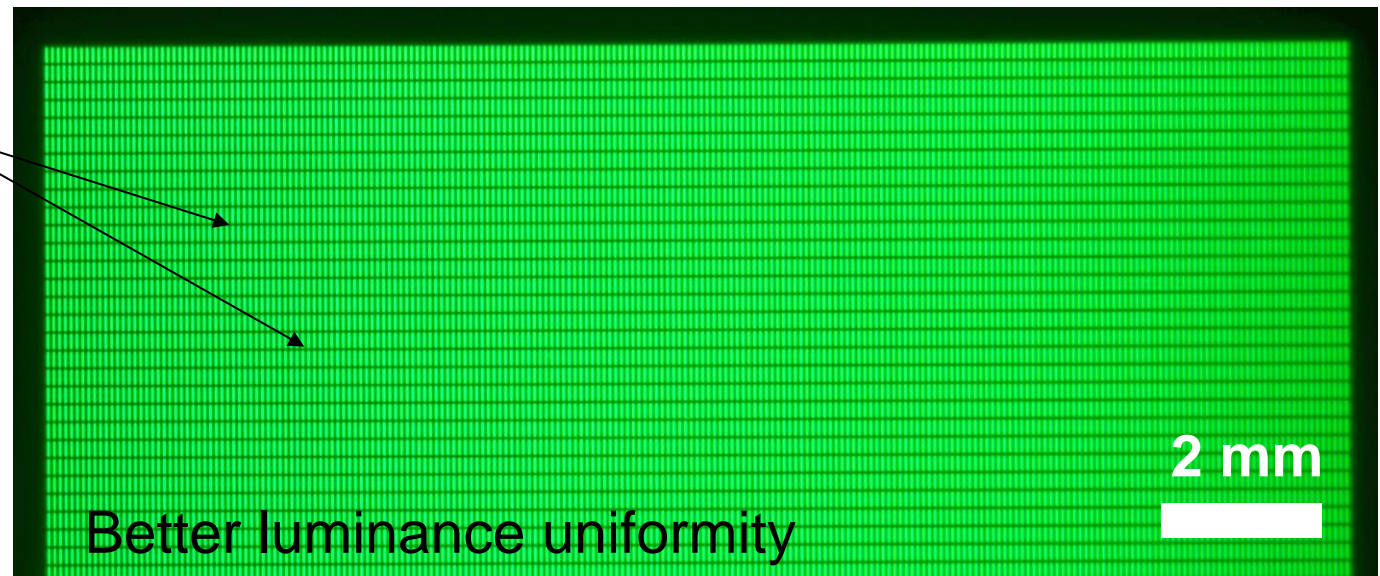


Inter-Pixel Short Range Uniformity: Luminance Stitch from Multi-Nozzle Printing

Periodic luminance
variation
~7%

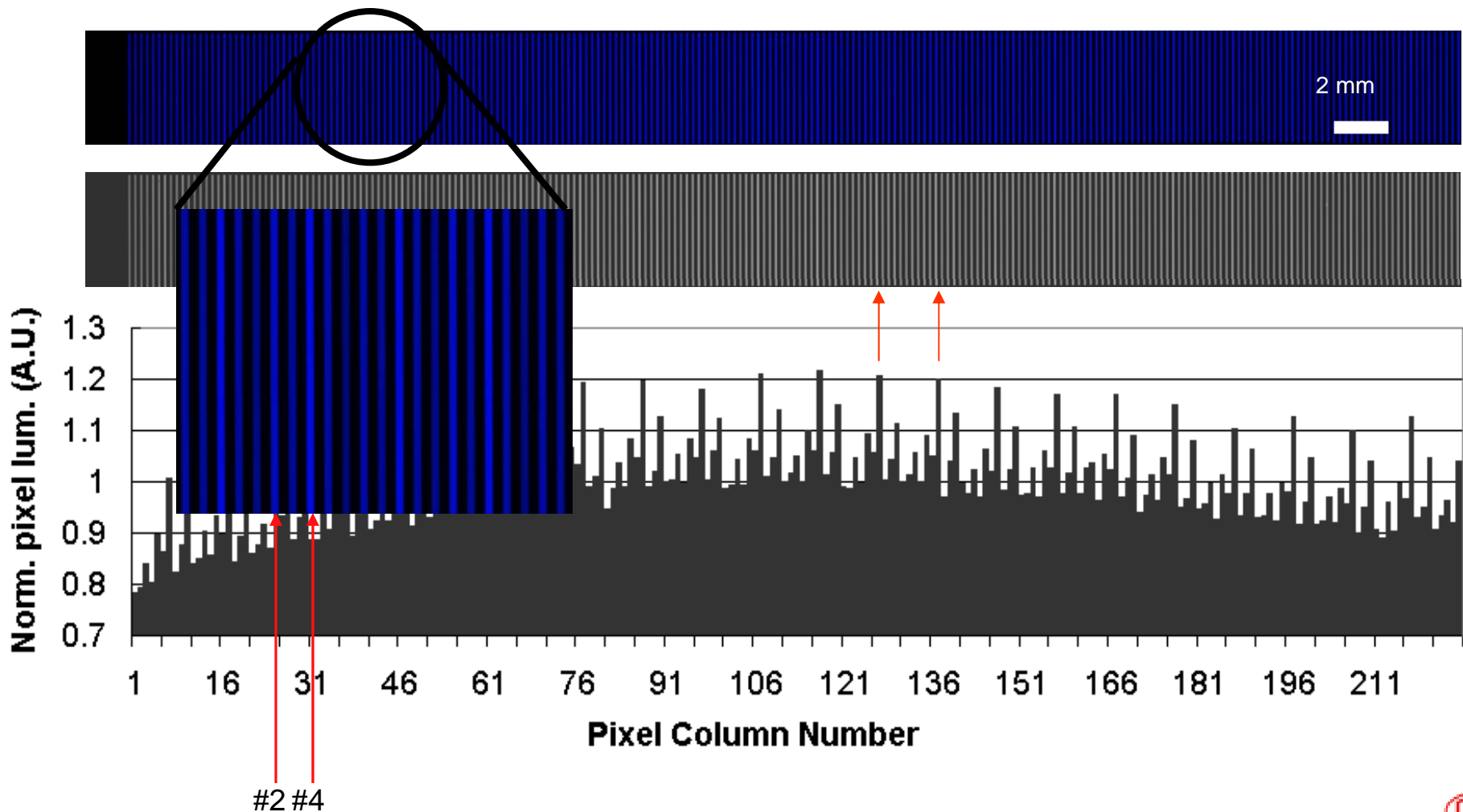


<3% periodic
luminance variation



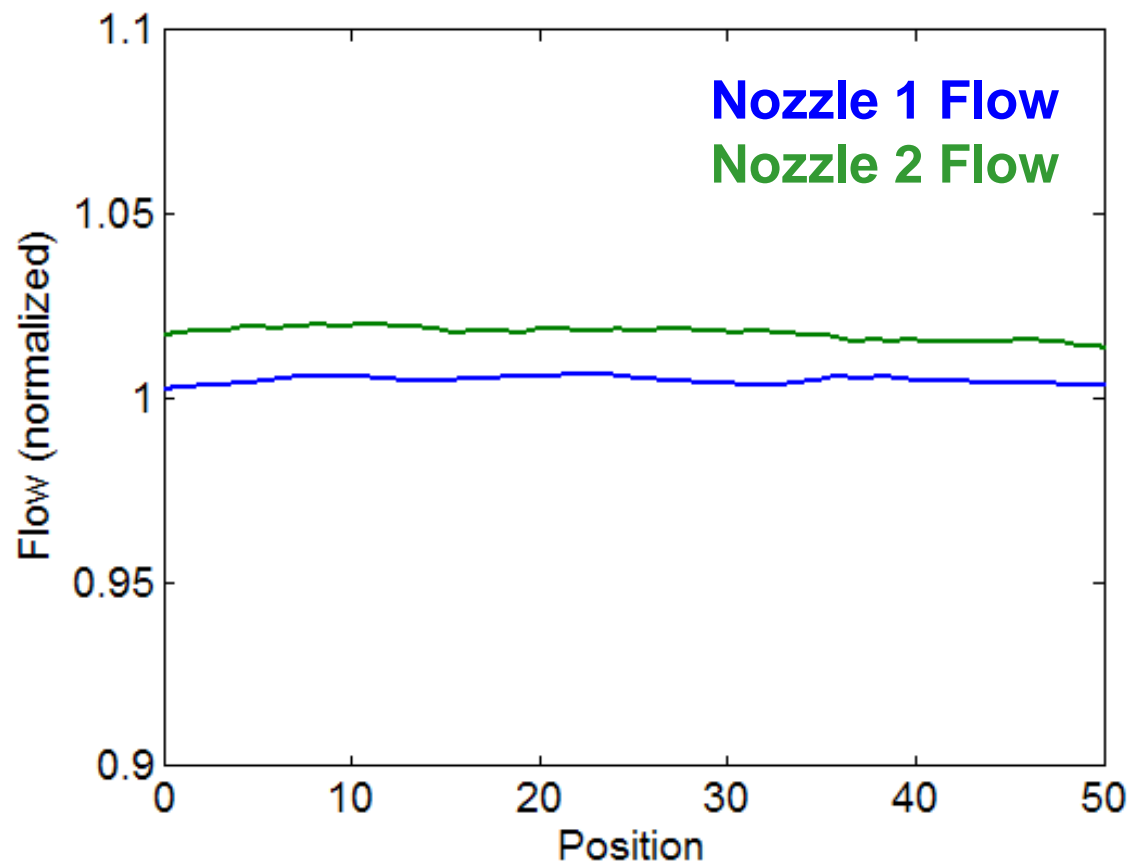
Inter-Pixel Short Range Uniformity: Measuring Visible Multinozzle Stitch

This example (5 nozzles) shows Nozzle #2 and #4 produce pixels which are noticeably different than the other three nozzles

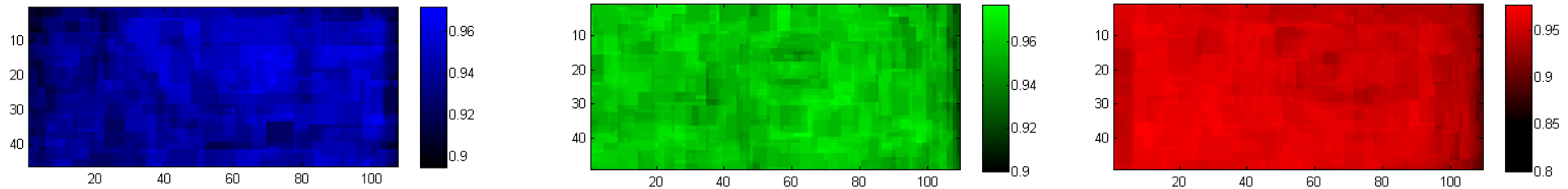


Sensitivity of Stitch Optical Measurement

Small intentional offset in flow used to test the sensitivity of the measurement



Assessing Inter-Pixel Short Range Uniformity Using a Display Industry Metric




$$U_{sh} = \frac{\sum_{i=0}^{n-1} \sum_{j=0}^{m-1} U_{r_{ij}}}{n \times m} \quad U_{r_{ij}} = 1 - \frac{L_{64 \max} - L_{64 \min}}{L_{64 \max}}, \quad L_{64 \max} = \max_{i=0 \dots 7, j=0 \dots 7} L_{ij}, \quad L_{64 \min} = \min_{i=0 \dots 7, j=0 \dots 7} L_{ij}$$

Item	U_{SH}
AMOLED Blue sub-pixels	0.94
AMOLED Green sub-pixels	0.94
AMOLED Red sub-pixels	0.95
Commercial AMLCD*	0.93

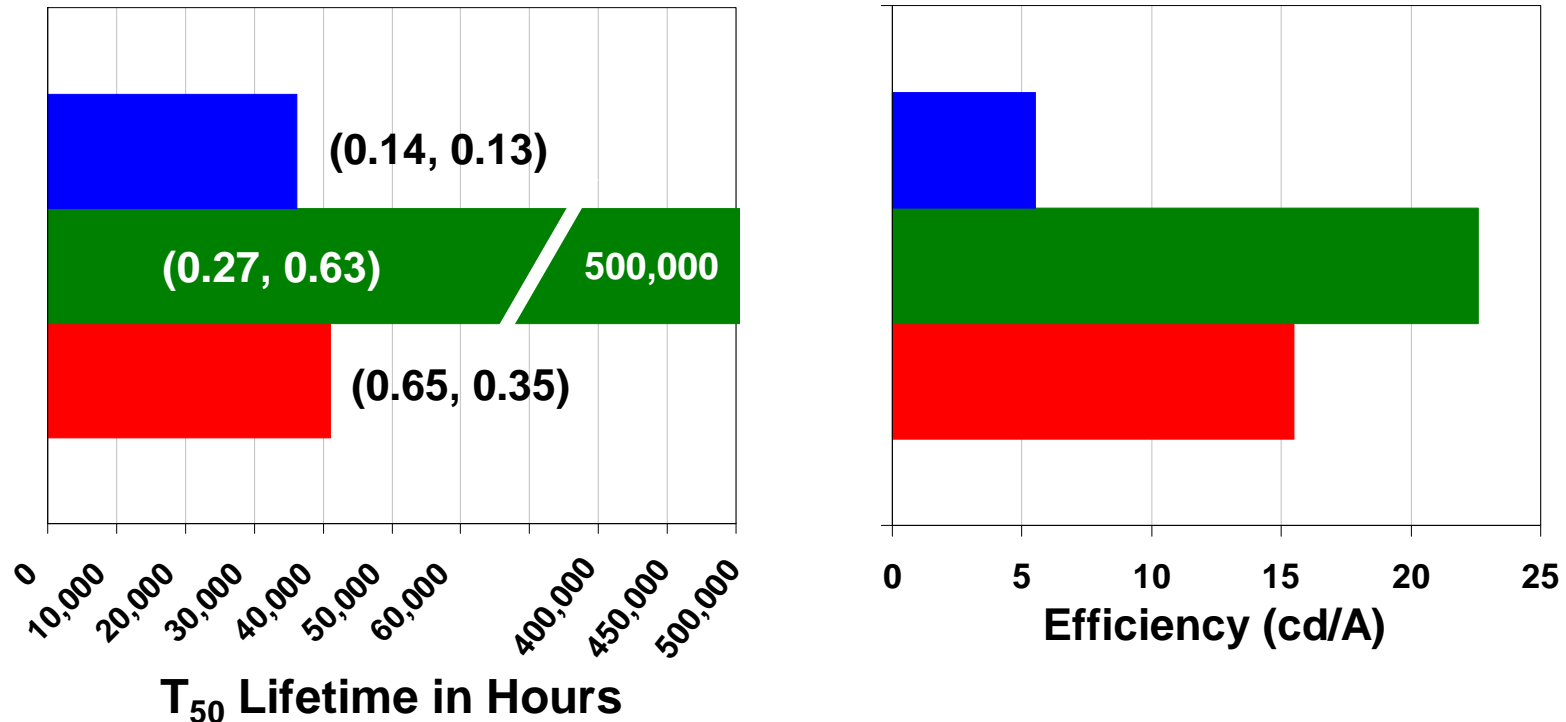
* A. Arkhipov, B-w. Lee, K. Park, C. Kim, and J. Lee, "New Metric for Short-Range Uniformity of AMOLEDs", IMID Digest P-81, pp. 488-491 (2008)

The transition to commercial printed devices – multinozzle printing for rapid TAC time



**Uniform monochrome display
printed with
five nozzles on G4 printer
4.3" dia. 128 ppi**

Printed Lifetime T_{50} Adjusted Display Life Time (100% on)



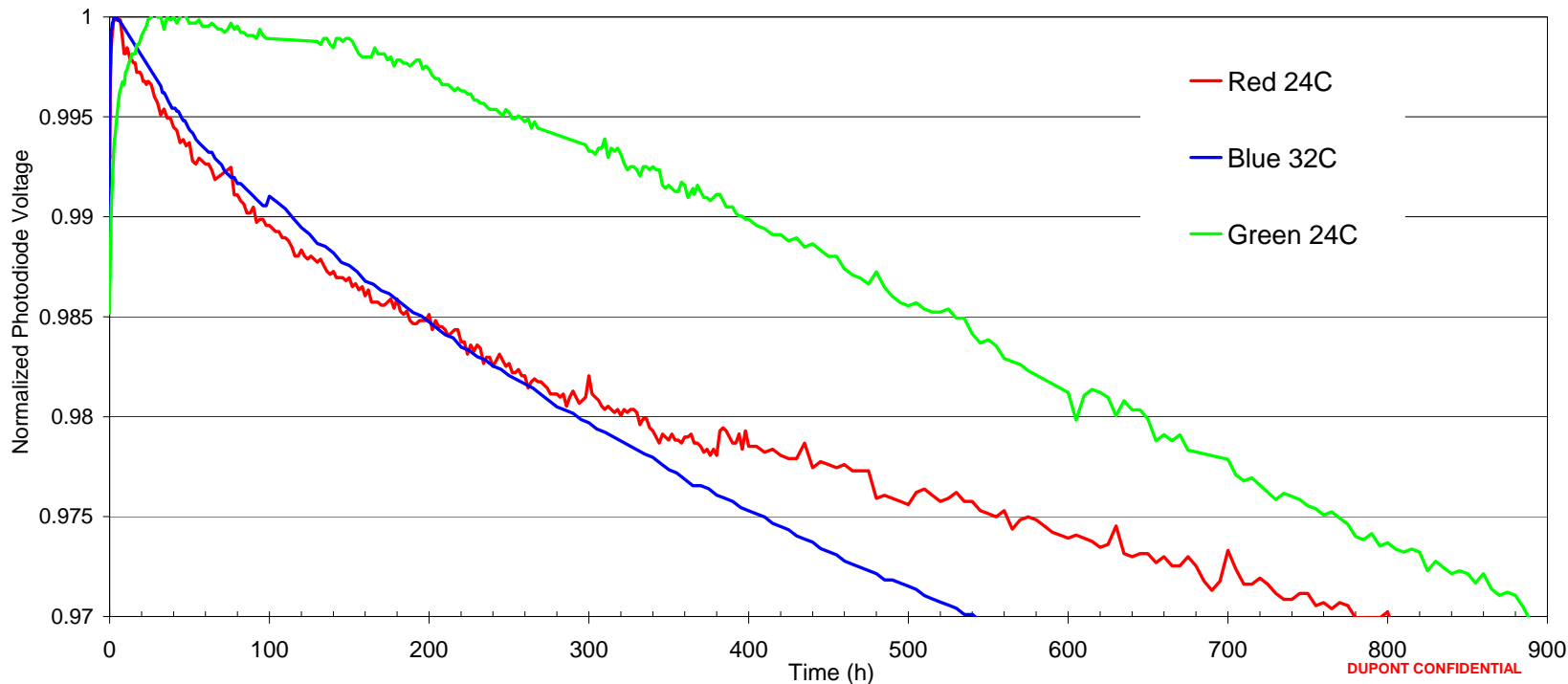
Printed bottom emission test coupons with no outcoupling enhancement. Common architecture converted to 200nits front-of-screen (white point CIE 0.31,0.32) with 40% aperture ratio, 46% transmission circular polarizer at 100% duty cycle.

Lifetime data reported at 20°C

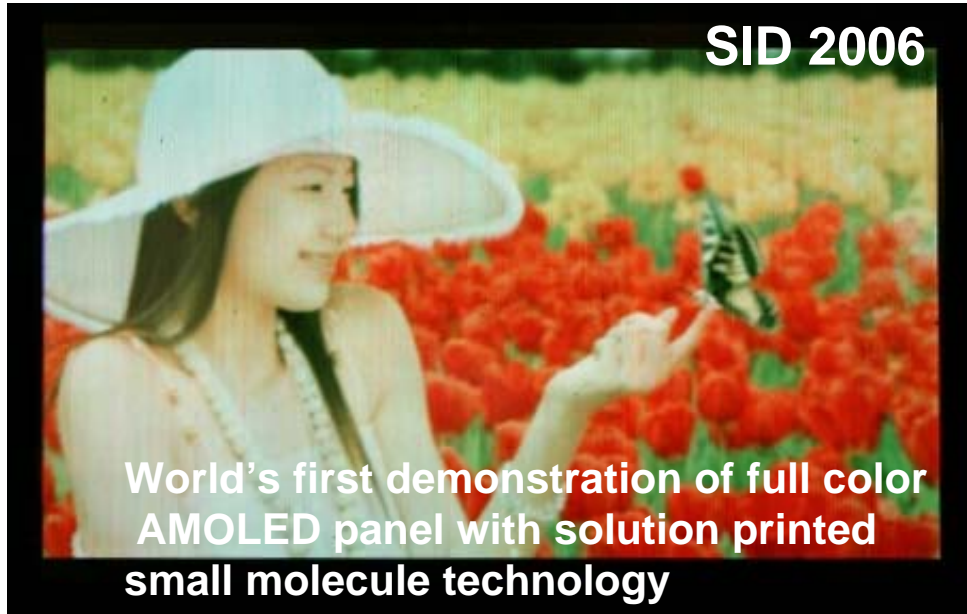
New Material Solutions to Address Image Sticking: Spin Coated Test Coupons, Common Architecture, No Burn-In

Color	Luminance (nits) ¹	Efficiency (cd/A)	Voltage	CIE (x,y)	T97 (hours)	Lifetest Temperature (°C)
Red	914	20.6	5.8	(0.65, 0.35)	800	24
Green	1845	89	3.9	(0.34, 0.63)	900	24
Blue	934	6	4.8	(0.14, 0.14)	500	32

¹Simulates 200 nit FOS white with CIE = (0.28, 0.29), 40% AR, and 44% polarizer transmittance



Progress of DDI Solution Processing



2010



4.4" AMOLED
Segment of 40" HDTV
Printed solution-processed display

2011



5.8" AMOLED
83 ppi
1.1 mm thick

Summary- OLED Display Materials/Process Development

- Solution processing is a key to cost competitive large area OLED displays
- DuPont proprietary materials and associated process technology can now deliver lifetime and color performance in line with anticipated first product OLED TV demands in a solution-processed, printed device.
- The challenges of rapid and large area patterning have been largely resolved using these materials and an understanding of their device physics, coupled with process engineering tied to the materials' properties.

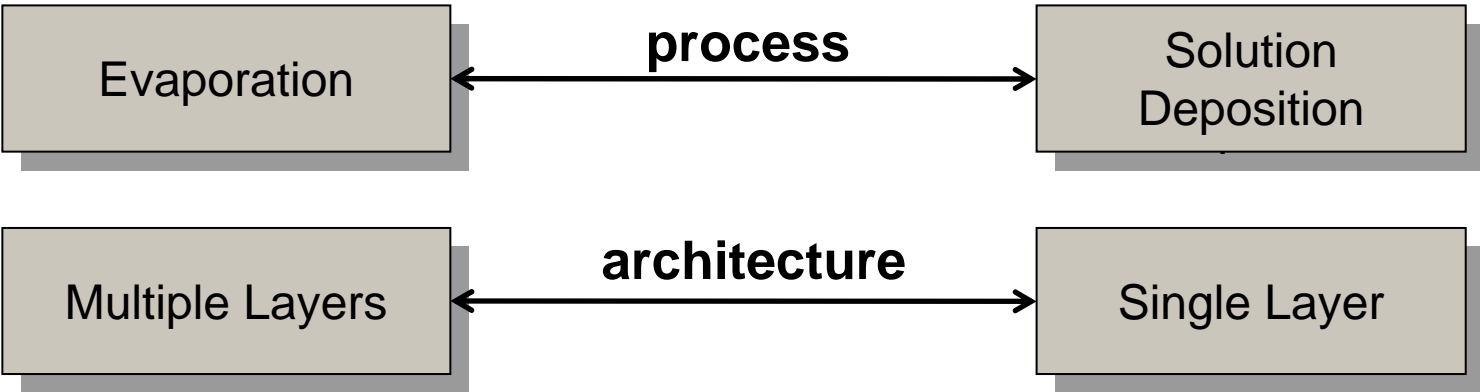
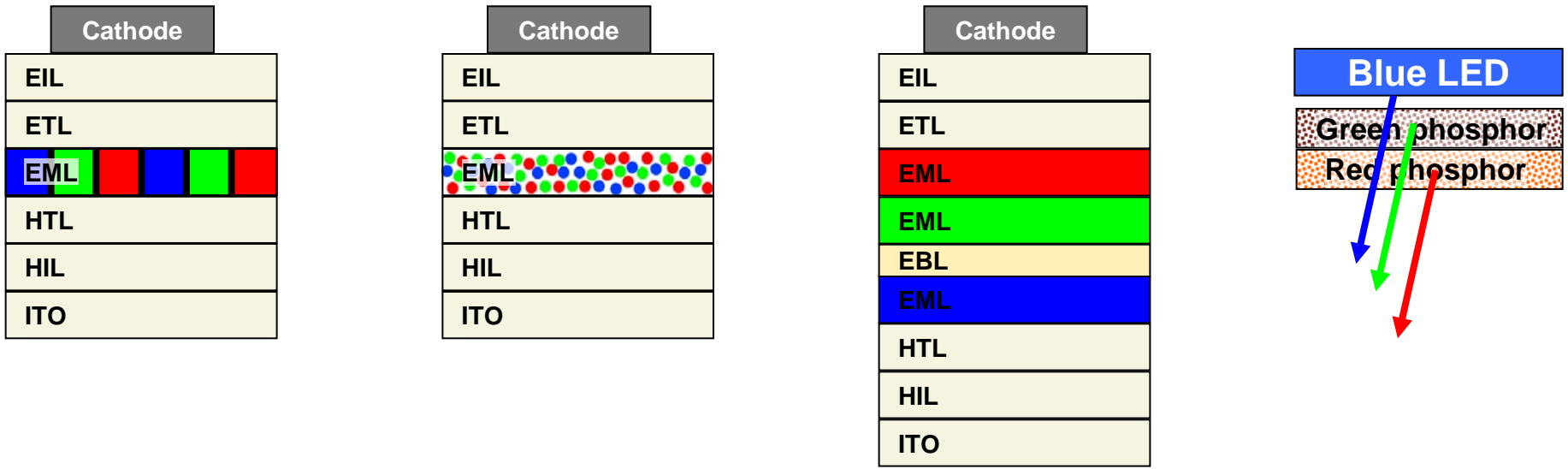
Agenda

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- Introduction to OLED lighting work at DuPont

OLED Lighting Challenges

- **OLED form is exciting, but not compelling by itself**
 - Counting on OLED's unique planar form factor to drive adoption is NOT a viable strategy considering the investment to be made
 - OLEDs must deliver the lowest total cost of ownership along with unique functionality
- **Lighting cost targets are brutal**
 - Manufacturing cost will dominate the cost equation for OLED lighting
- **Window of opportunity may be short**
 - LED lighting is already (somewhat) commercial, continues to improve and is becoming less expensive

Many Ways to Generate White Light with OLEDs



In lighting, cost dominates.
 We need to choose a manufacturable structure and develop the technology to enable it

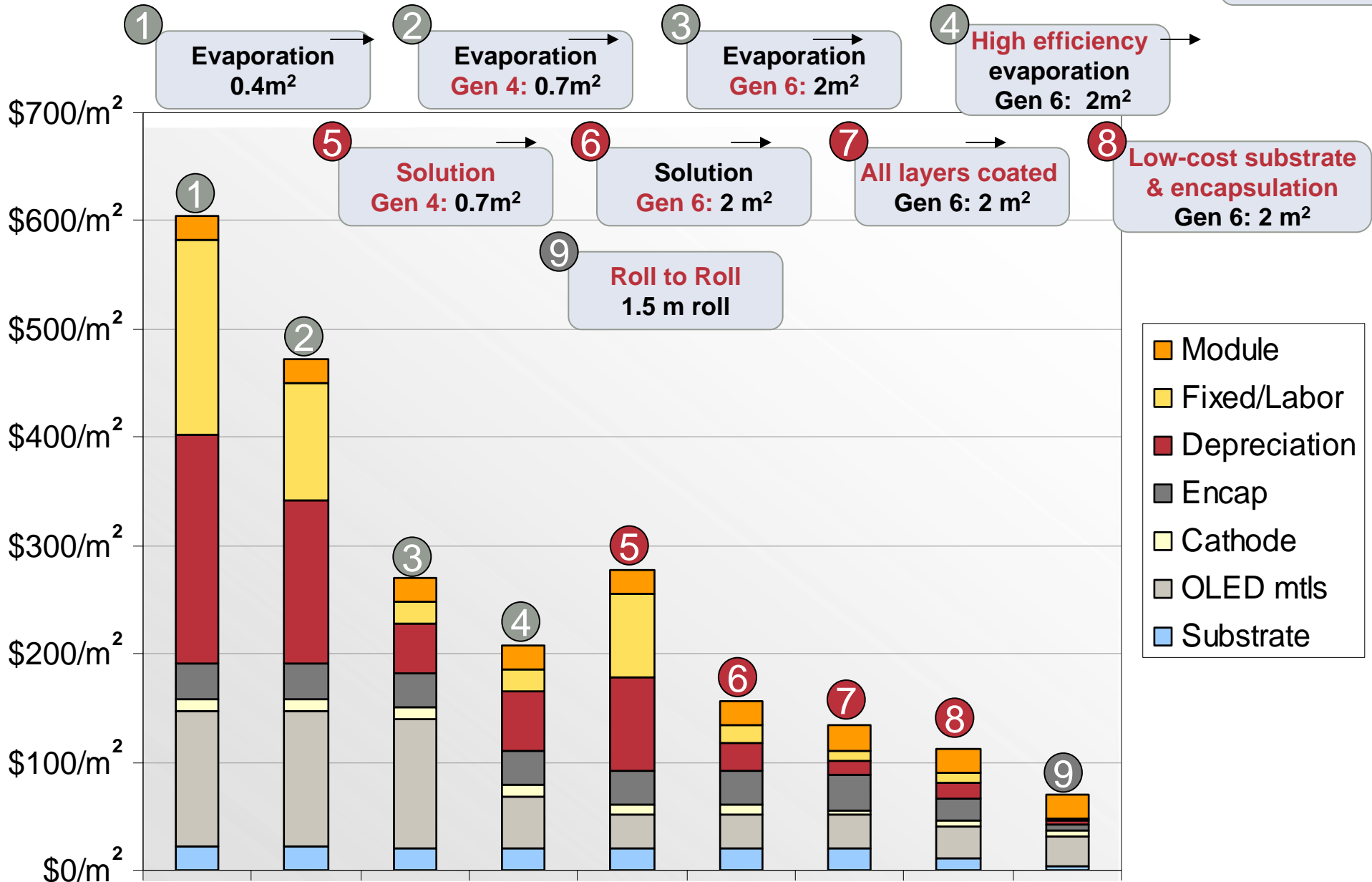


Five Ways to Reduce Cost

- Minimize layers
- Scale up (size and volume)
- Reduce material cost and waste
- Low cost lighting substrates
- Reduce encapsulation cost

Manufacturing cost roadmap

Process Substrate



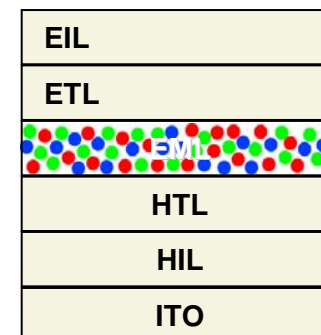
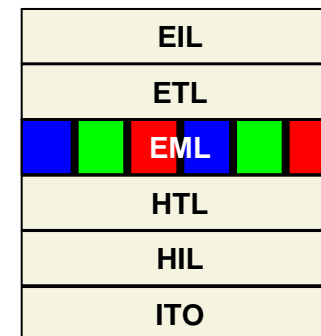
Module cost assumes 0.4m² lamp

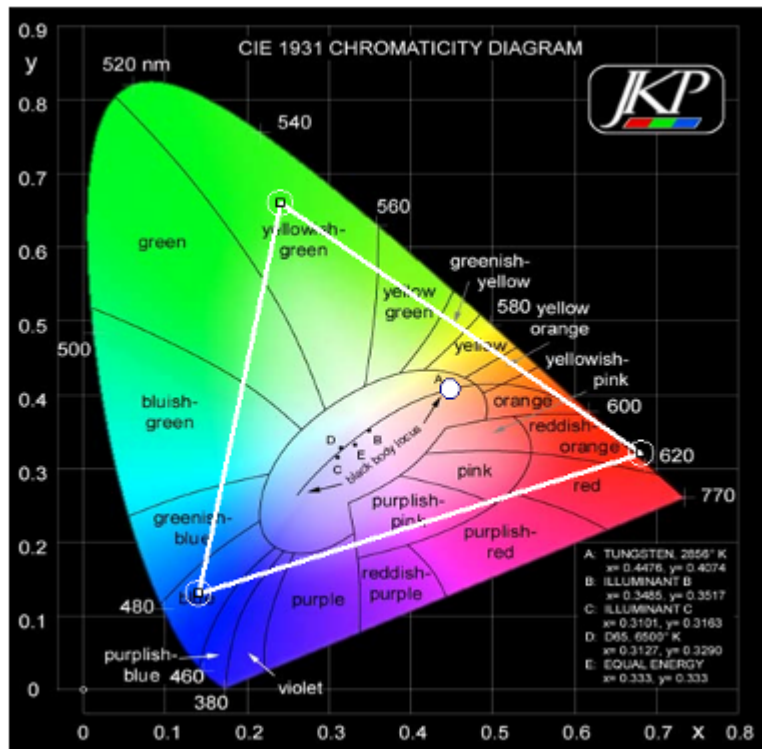


Overview of OLED Lighting Work at DuPont

OLED Lighting represents a new area for DuPont. Two research programs have recently been activated.

1. We received a US Department of Energy (DOE) grant to evaluate printing of OLEDs for color tunable lighting (spatially separated emitters)
2. We are a subcontractor for GE on program supported by DOE to develop solution-coated, roll-to-roll manufacture of OLED Lighting (single emissive layer coated from solution)



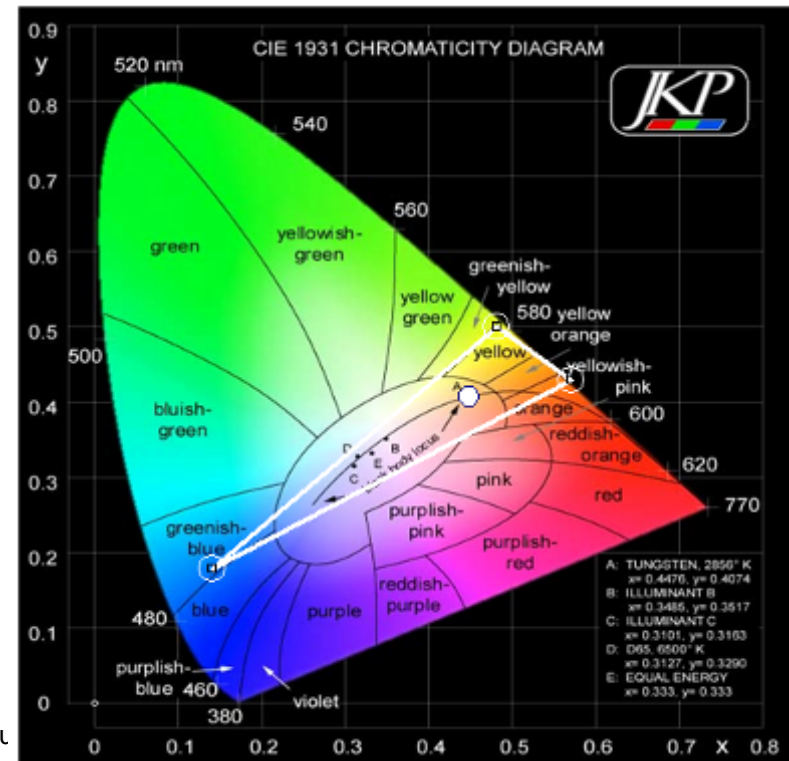


For displays we choose materials that give us a large 'color gamut' in order to best represent video images

We don't need this wide range of colors for white lighting.

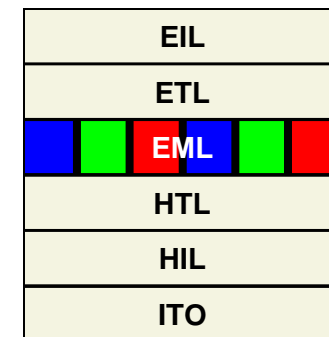
We can select our best materials based on highest efficacy instead.

While our standard materials are certainly capable of achieving the SSL color gamut, our models suggests that an alternative materials set (with lower gamut) can give 3x higher lm/W performance.



DISPLAY COLORS	CIE	Lm/W with OE	EQE (%) with OE	Cd/A with OE
Red	(0.645, 0.354)	10	17	22.1
Green	(0.266, 0.629)	12	6	23
Deep Blue	(0.140, 0.140)	3	4	6.2

These give a combined performance of **8 lm/W @ 1,000 nits** for white (illum. A)

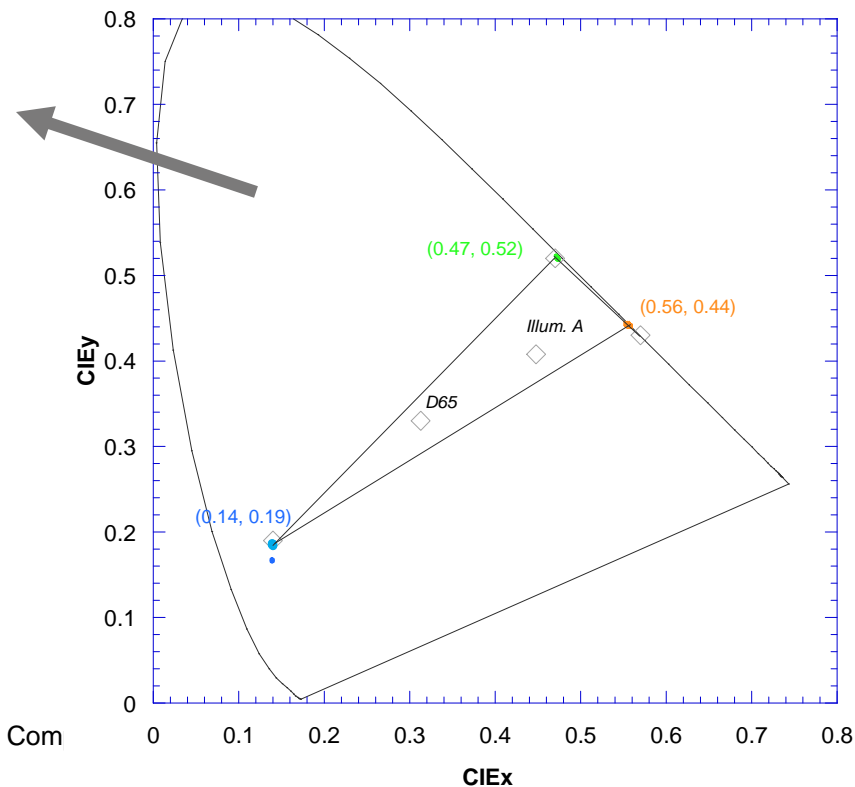


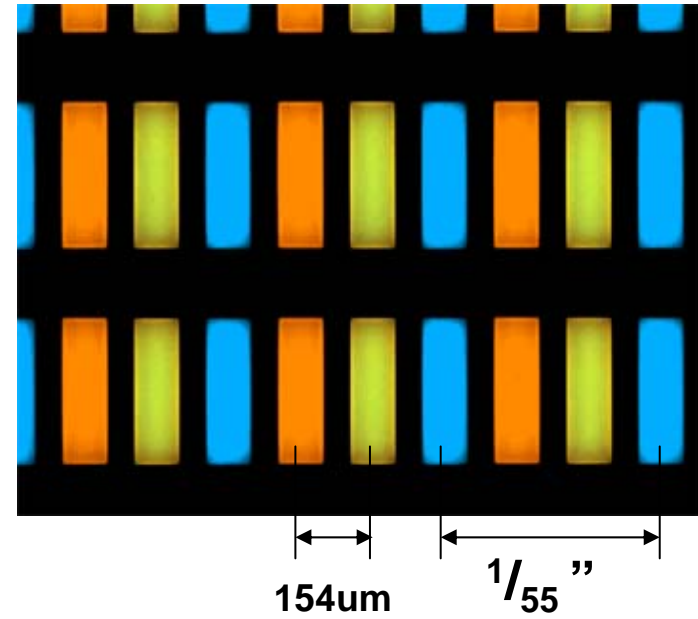
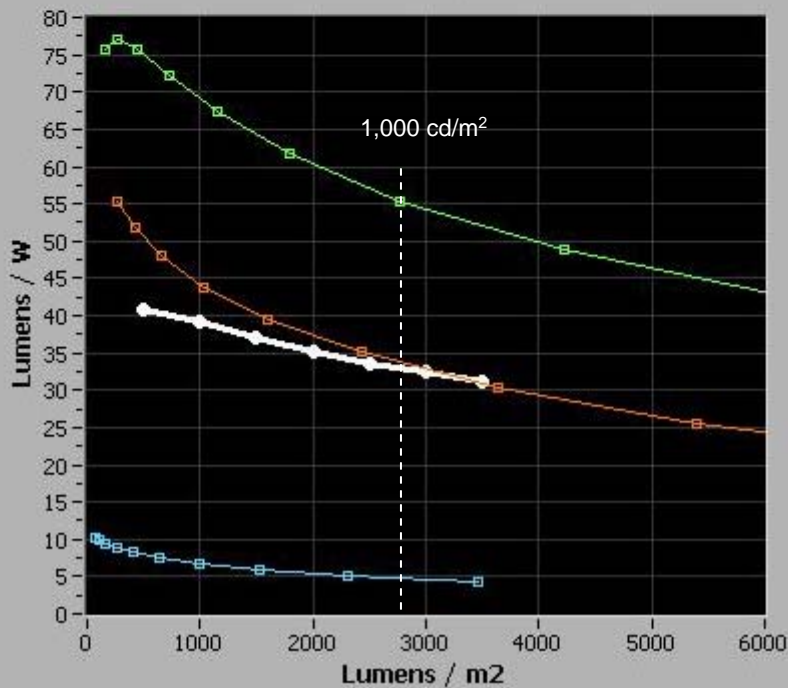
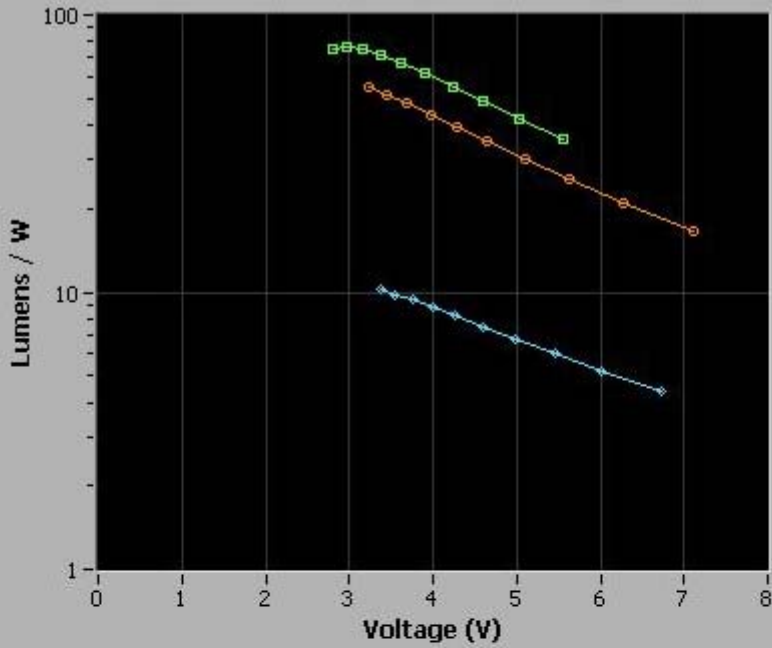
LIGHTING COLORS	CIE	Lm/W with OE	EQE (%) with OE	Cd/A with OE
Orange	(0.56, 0.44)	33	20%	57
Yellow	(0.47, 0.52)	55	22%	78
Pale Blue	(0.14, 0.19)	5	6%	10

Whereas these give a combined performance of **> 30 lm/W @ 1,000 nits** (illum. A)

These data are for solution-processed devices with an EML printed in air. Emissive area is 50 cm²

All data are quoted at 1,000 cd/m² and include an outcoupling enhancement film (OE)

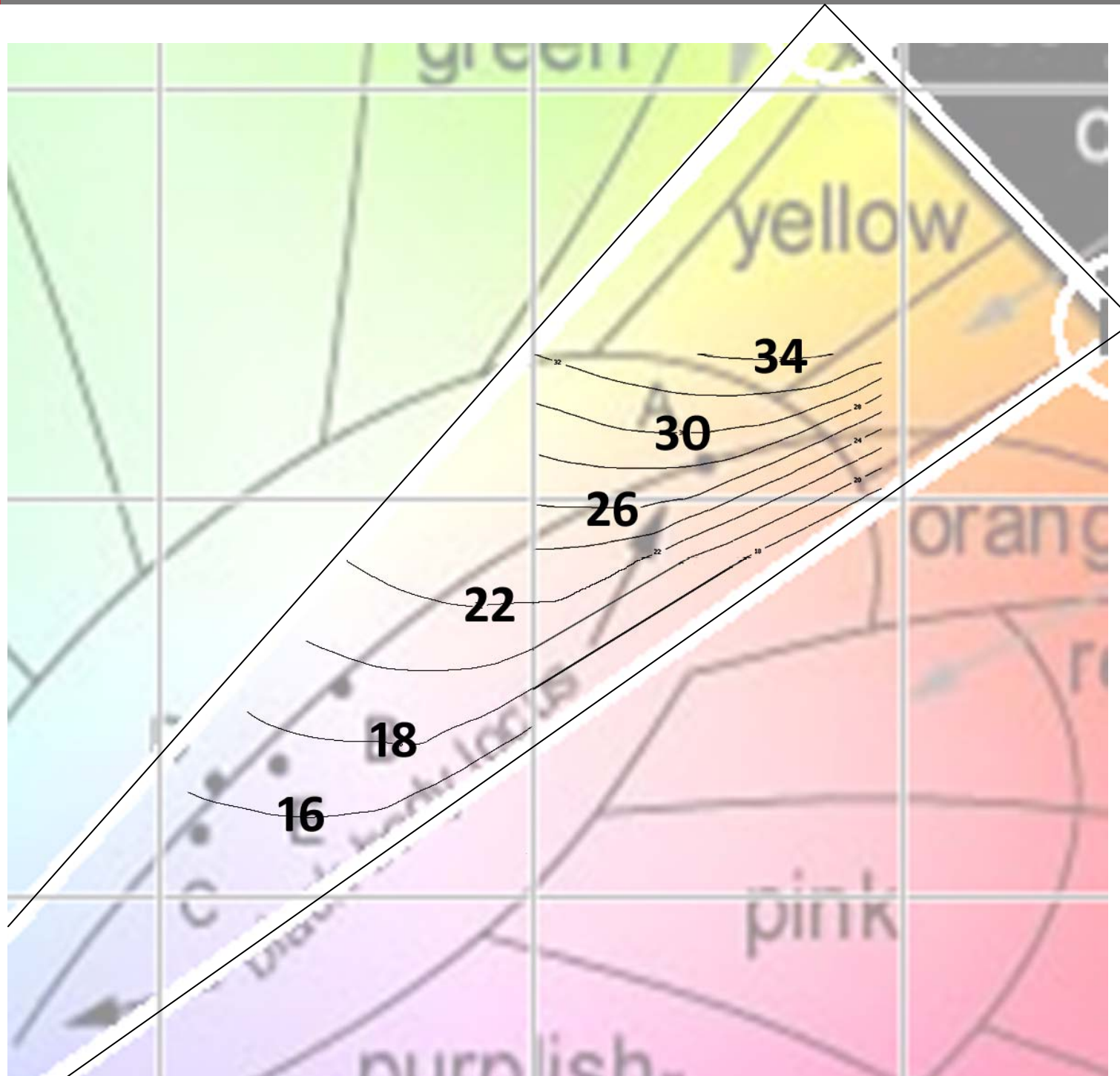


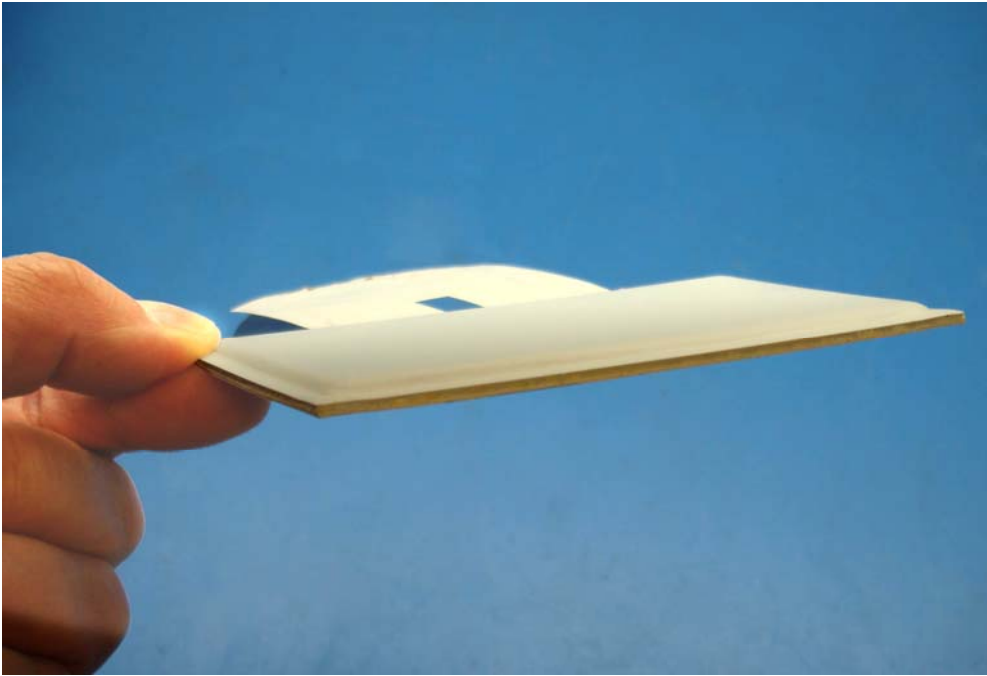


Orange – Yellow – Pale Blue combination showing the individual performance, and the combined performance of **> 30 lm/W @ 1,000 nits (illum. A)**

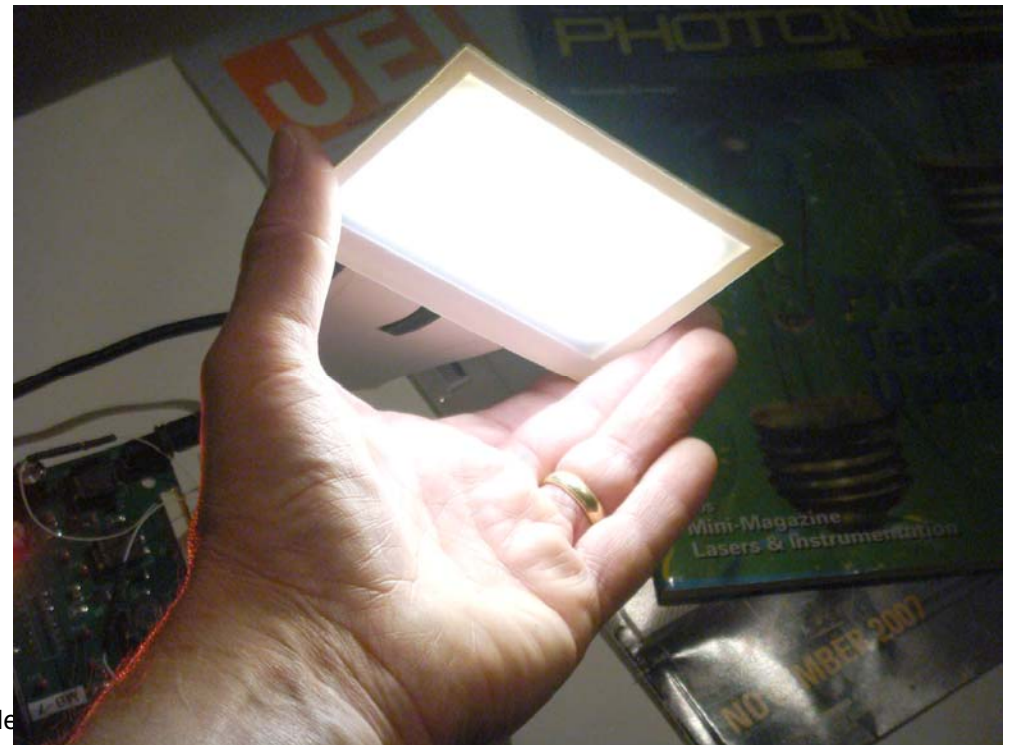
The 3 'primary' colors can be individually controlled to give a color-tunable device.

This plot shows the lm/W contours of these devices, for 'whites' of various color temperatures.





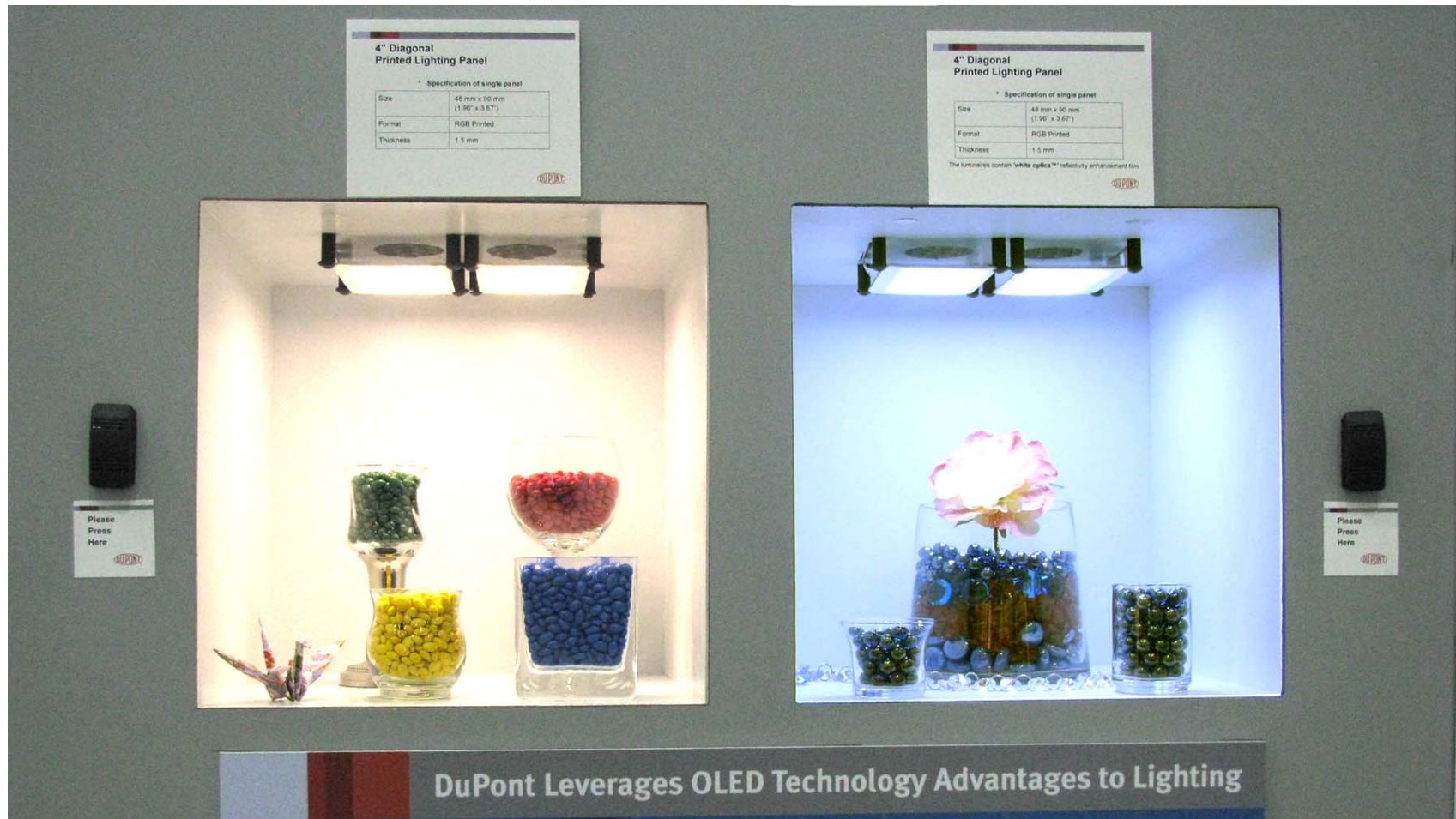
50 cm² emissive area, 4.3 mm thick



2 luminaires were fitted into each light box.

Each panel was running 1,500 – 2,000 nits

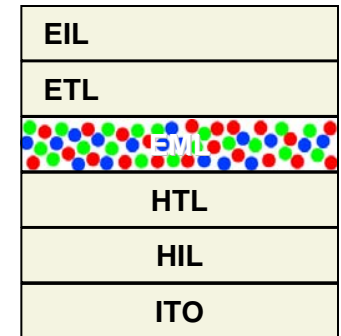
Visitors could scroll through a range of colors: 2700K white, 6500K white, or the O-Y-B primaries.



Materials Development for GE R2R Process

DuPont focus:

- Long lifetime high efficiency emitters, especially blue
- High triplet energy HTL to prevent blue quenching
- A common host for blue, green, and red dopants



It is expected that DuPont will deliver many iterations of materials modifications based on GE and internal testing and feedback which will occur throughout the program.

So far we've found that

- DuPont green and red emitters developed for displays can be used in GE's process.
- HIL formulation was modified for GE's process
- Status (no outcoupling enhancement):

CRI	CCT	ΔBB	PE, lm/W	EQE, %	V, V
88	3395	0.03	24.5	15.4	4.4

2010 Wet-Coated Green/Red OLEDs

- All 4 organic layers wet-coated
- Metal-based small-molecule OLEDs

		T70 (hrs)	T50 (hrs)
wet {	Cathode		
	Electron injection layer		
	Electron transport layer		
	Emissive Layer		
	Red	55,000	~130,000
	Green	~170,000	~300,000
	Hole transport layer		
	Hole injection layer		
	ITO anode		

Wet-coated OLEDs can have LED-like lifetime

DOE SSL (DE-EE-0003250) (2010-2012)



Conclusions

Through our work on AMOLED displays, we developed a strong level of competency in process and materials development for solution-coated OLED devices.

We are beginning to apply this knowledge to the development of materials for OLED solid-state lighting.

Our approach is based upon reduction in total cost of ownership (manufacturing and maintenance) through the use of solution-processing techniques and simplified device architecture.